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Agenda







Advanced Packaging



Strong Demand Across Multiple Solutions

Thermo Compression Bonding ("TCB")

Logic:

- Order momentum for C2W from leading IDM continued in Q3
- Joint development on next-gen fluxless tool with leading foundry is still ongoing
- Meaningful C2S orders from leading foundry's OSAT; shipment commenced in Q3

High bandwidth memory ("HBM"):

Significant breakthrough with bulk order win from a leading player in October. Order wins based on unique TCB capabilities:

- Enable seamless upgrade to fluxless applications for 12H & beyond
- Provide fungibility to handle different packaging processes (NCF, MUF flux / fluxless)

Photonics:

- Photonics: Meaningful order wins; in line with robust demand for 800G optical transceivers for data centres
- Silicon Photonics: Won orders for high-end optical communication related applications

Hybrid Bonding ("HB")

Shipped the first tool to a logic customer in Q3

Physical Vapor Deposition	Electro- Chemical Deposition (Wafer/ Panel Level Plating)*	Laser Singulation [*]	Wafer / Panel Level Fan-out*	Photonics*		Mass Transfer & Bonding (Advanced Displays)		Multi-Chip Module Bonding	Thermo Compression Bonding*	Hybrid Bonding*	SMT SiP Printing	SMT SiP Placement [*]
				THE IN								
Apollo	Stratus	LASER1205	NUCLEUS SIPLACE CA	NANO NOVA	Photon Pro	VORTEX II	AD300 PRO	VECTOR	FIREBIRD	LITHOBOLT	DEK Galaxy	SIPLACE TX micron

Comprehensive Range of Advanced Packaging Solutions



Q3 2024 Key Financials





Revenue

US\$429M

(-3.7% YoY)¹ (+0.1% QoQ)¹



Bookings

US\$406M

(+7.1% YoY)¹ (+1.5% QoQ)¹



Backlog US\$806M

(-13.3% YoY)¹ (-2.2% QoQ)¹

Gross Margin

41.0%

(+683 bps YoY) (+94 bps QoQ)



Operating Margin

5.3%

(+343 bps YoY)

(+129 bps QoQ)



Adjusted Net Profit²

HK\$30M

(-35.0% YoY)

(-78.5% QoQ)



Adjusted EPS²

HK\$0.08

(-27.3% YoY)

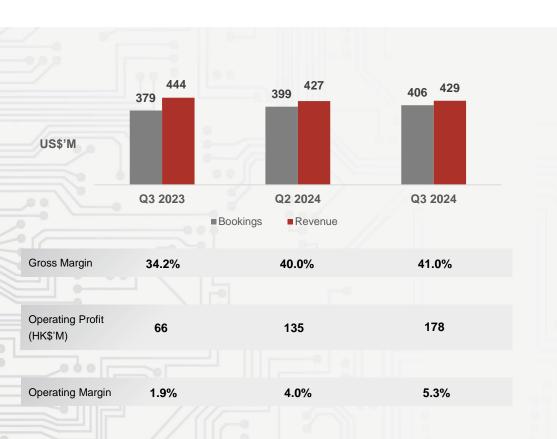
(-75.8% QoQ)

Note:

¹ The YoY & QoQ % comparison is based on financials denominated in HK\$

Q3 2024 Group Financial Results





Revenue

- At high end of guidance
- SEMI increased; SMT declined

Bookings

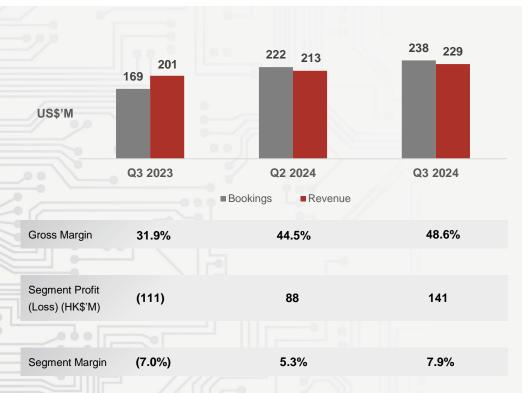
- Strong YoY growth due to SEMI
- Book-to-bill at 0.95; improved YoY & QoQ

Gross margin

Significant YoY improvement due to SEMI

Q3 2024 Semiconductor Solutions Segment Performance





Revenue

- IC/Discrete: Increased QoQ, mainly driven by mainstream die & wire bonders
- Optoelectronics: Increased QoQ, mainly from photonics
- CIS: Declined QoQ due to seasonality

Bookings

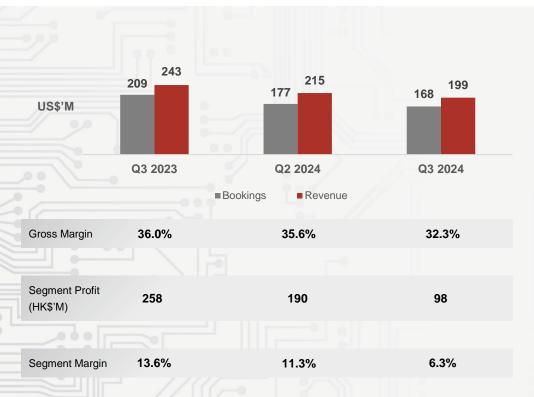
- Increased QoQ, driven by mainstream wire & die bonders
- Book-to-bill >1 since Q1 2024
- YoY growth for 4 consecutive quarters

Gross margin

 Increased QoQ, driven by higher manufacturing utilisation due to TCB production ramp

Q3 2024 SMT Solutions Segment Performance





Revenue & Bookings

- Declined due to ongoing softness in SMT's overall market
- Maintained leading market position

Gross margin

Declined due to product mix & volume effect



AAMI: Proposed Transaction



As announced on 23 October 2024, the Group has proposed to dispose of its stake in its strategic joint venture, Advanced Assembly Materials International Limited ("AAMI") to Shenzhen Original Advanced Compounds Co., Ltd. ("SOAC")¹ in consideration of new shares to be issued by SOAC and the remaining consideration in cash.

Besides the immediate cash flow that the Group would receive on completion, this proposed transaction may potentially create additional value for ASMPT shareholders as the Group would receive no less than 20% of the shares in SOAC with further potential to grow its value in the semiconductor materials field.



Outlook & Q4 2024 Revenue Guidance



Near-term outlook:

- Remain confident about advanced packaging prospects
- SMT bookings bottoming out
- SEMI mainstream recovery slower than anticipated

Q4 2024 Revenue Guidance

Considering the above and seasonality effect, the Group expects Q4 2024 revenue to be:

US\$380m to US\$460m

(-3.5% YoY and -2.0% QoQ at mid-point of guidance)







Reconciliation to Non-HKFRS Measures



The below tables highlighted the reconciliations of the Group's financial measures prepared in accordance with Hong Kong Financial Reporting Standards ("HKFRS") for Q3 2024, Q2 2024 and Q3 2023 to the non-HKFRS measures:

		Q3 2024					Q2 20	24	Q3 2023				
1			Non-HKFRS adjustments				Non-HKFRS a	djustments			Non-HKFRS adjustments		
	Group	As reported	Restructuring costs	Income tax effect	Adjusted	As reported	Restructuring costs	Income tax effect	Adjusted	As reported	Restructuring costs	Income tax effect	Adjusted
Ī	Net profit (HK\$'M)	23.8	7.5	(1.8)	29.5	136.7	0.5	(0.1)	137.1	12.8	40.4	(7.8)	45.4
	Net profit margin	0.7%			0.9%	4.1%			4.1%	0.4%			1.3%
	Basic EPS (HK\$)	0.06	-		0.08	0.33		00 /	0.33	0.04			0.11

The Group has provided adjusted net profit and adjusted earnings per share which are supplementary to the Group's consolidated results in accordance with HKFRS. The Group believes that these additional figures provide our shareholders and investors with useful supplementary information about our ongoing operating performance and facilitates the analysis and comparison of financial trends and results between periods. The adjusted net profit and adjusted earnings per share exclude the impact of restructuring costs which were mainly related to employee severance and benefit arrangements.

The use of these non-HKFRS measures may have certain limitations as a tool for analysis and comparison. Shareholders and investors are advised not to consider these non-HKFRS measures in isolation from, or as a substitute for analysis of, the Group's financial performance as reported under HKFRS. Also, please note that these non-HKFRS measures may be defined differently from similar terms used by other companies.